



FPNH10



NPN RF Transistor

This device is designed for use in low noise UHF/VHF amplifiers, with collector currents in the 100 μ A to 20 mA range in common emitter or common base mode of operations, and in low frequency drift, high output UHF oscillators. Sourced from Process 42.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	25	V
V _{CBO}	Collector-Base Voltage	30	V
V _{EBO}	Emitter-Base Voltage	3.0	V
I _C	Collector Current - Continuous	50	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

These ratings are based on a maximum junction temperature of 150 degrees C.
These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

Thermal Characteristics TA = 25°C unless otherwise noted				
Symbol	Characteristic	Max	Units	
		FPNH10		
PD	Total Device Dissipation	350	mW	
	Derate above 25°C	2.8	mW/°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W	

*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

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FPNH10 Rev. A

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(continued)

Symbol	Parameter	Test Conditions	Min	Max	Units
-					
OFF CHA	RACTERISTICS				
V _{(BR)CEO}	Collector-Emitter Sustaining Voltage*	I _C = 1.0 mA, I _B = 0	25		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	I _C = 100 μA, I _E = 0	30		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	vn Voltage $I_{\rm E} = 10 \mu {\rm A}, I_{\rm C} = 0$ 3.0			V
I _{CBO}	Collector Cutoff Current	$V_{CB} = 25 \text{ V}, \text{ I}_{E} = 0$		100	nA
I _{EBO}	Emitter Cutoff Current	V _{EB} = 2.0 V, I _C = 0		100	nA
ON CHAR	ACTERISTICS				
h _{FE}	DC Current Gain	I _C = 4.0 mA, V _{CE} = 10 V	60		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 4.0 mA, I _B = 0.4 mA		0.5	V
V _{BE(on)}	Base-Emitter On Voltage	I _C = 4.0 mA, V _{CE} = 10 V		0.95	V
SMALL SI	GNAL CHARACTERISTICS				
fT	Current Gain - Bandwidth Product	$I_{C} = 4.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 100 MHz	650		MHz

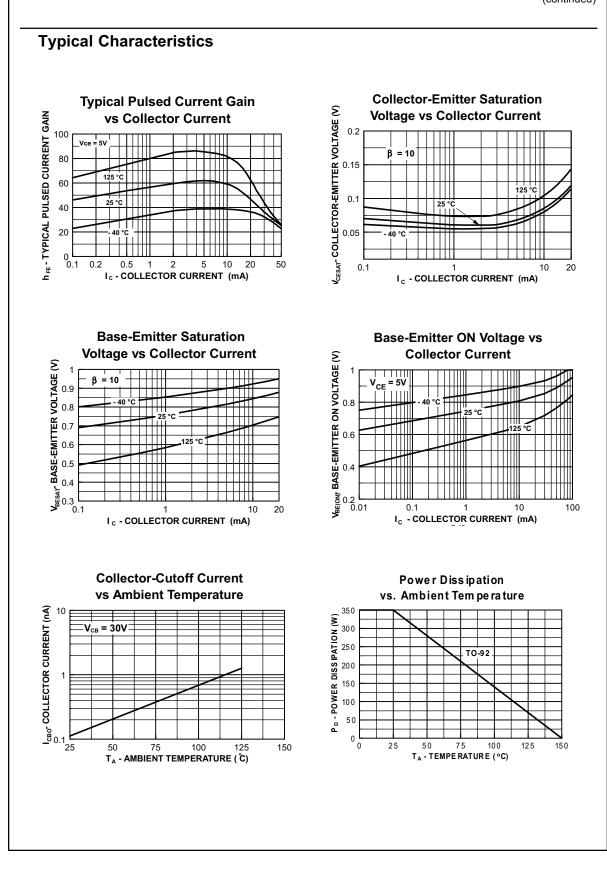
f⊤	Current Gain - Bandwidth Product	I _C = 4.0 mA, V _{CE} = 10 V, f = 100 MHz	650		MHz
C _{cb}	Collector-Base Capacitance	V _{CB} = 10 V, I _E = 0, f = 1.0 MHz		0.720	pF
C _{rb}	Common-Base Feedback Capacitance	V _{CB} = 10 V, I _E = 0, f = 1.0 MHz	0.34	0.65	pF
rb'C _c	Collector Base Time Constant	I _C = 4.0 mA, V _{CB} = 10 V, f = 31.8 MHz		9.0	ps

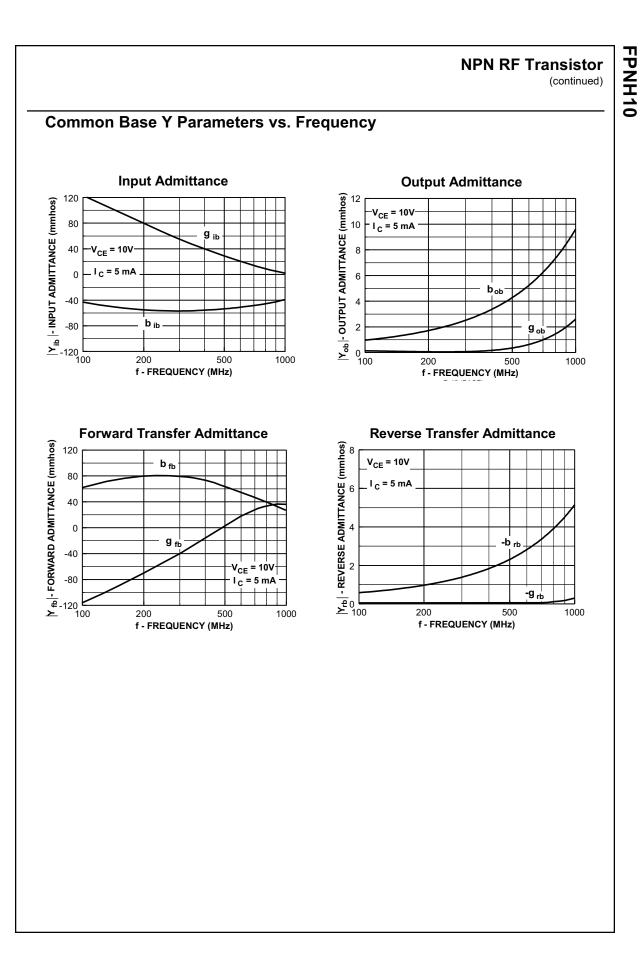
*Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%

Spice Model

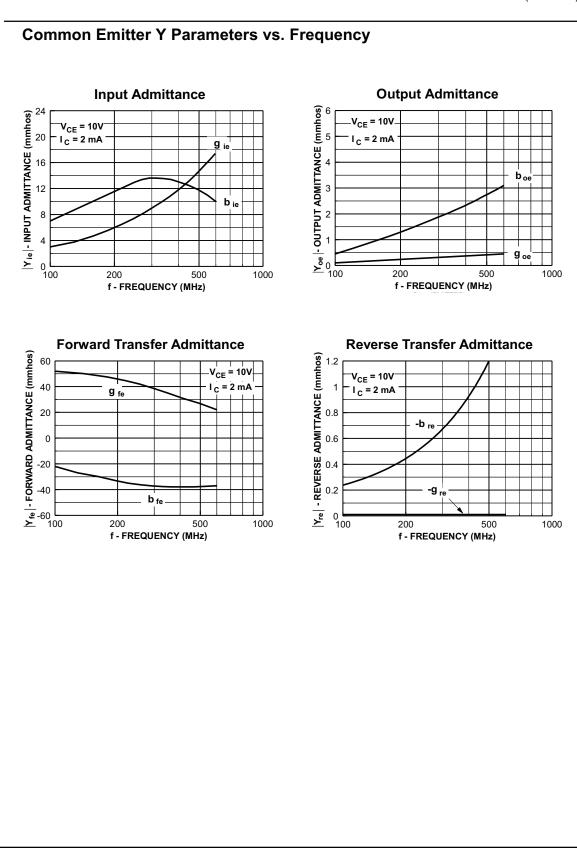
NPN (Is=69.28E-18 Xti=3 Eg=1.11 Vaf=100 Bf=308.6 Ne=1.197 Ise=69.28E-18 Ikf=22.83m Xtb=1.5 Br=1.11 Nc=2 Isc=0 Ikr=0 Rc=4 Cjc=1.042p Mjc=.2468 Vjc=.75 Fc=.5 Cje=1.52p Mje=.3223 Vje=.75 Tr=1.558n Tf=135.8p Itf=.27 Vtf=10 Xtf=30 Rb=10)

NPN RF Transistor (continued)

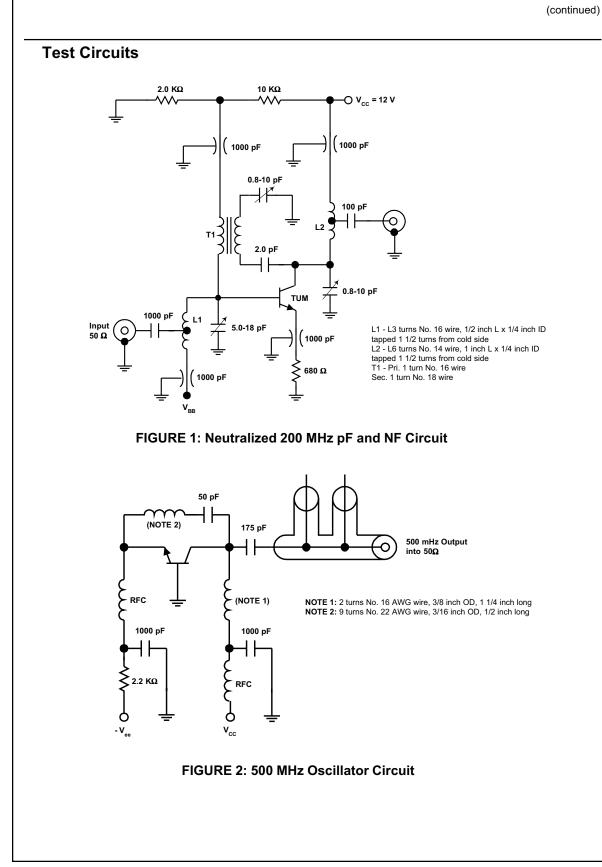








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